

PRELIMINARY SPEC

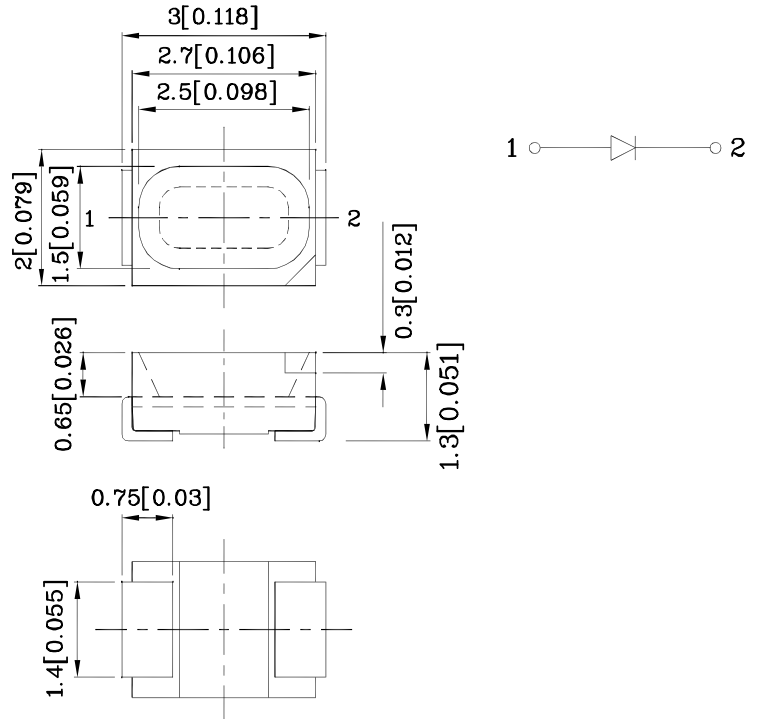
**Features**

- 3.0mm x 2.0mm, 1.3mm high, only minimum space required.
- Suitable for compact optoelectronic applications.
- Low power consumption.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 4.
- RoHS compliant.



Notes:

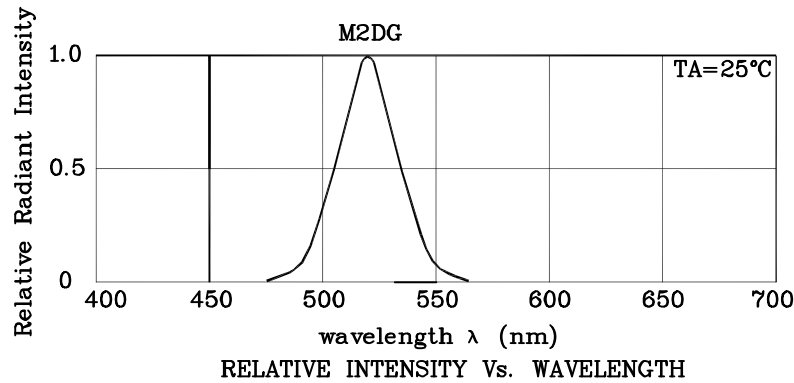
1. All dimensions are in millimeters (inches).
2. Tolerance is  $\pm 0.2(0.008)$ " unless otherwise noted.
3. Specifications are subject to change without notice.



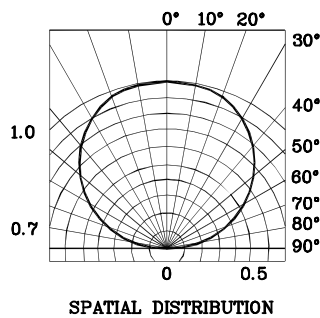
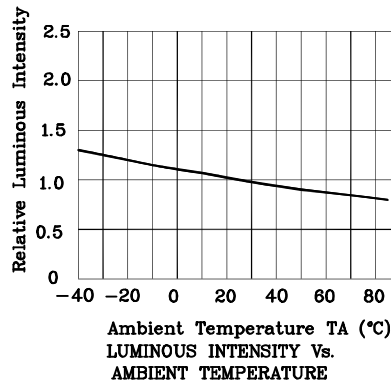
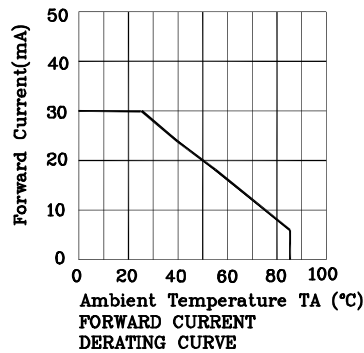
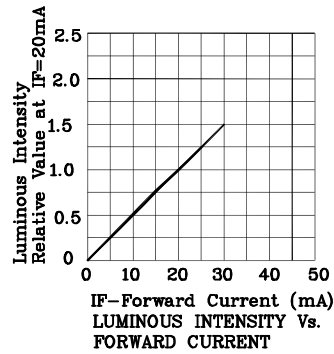
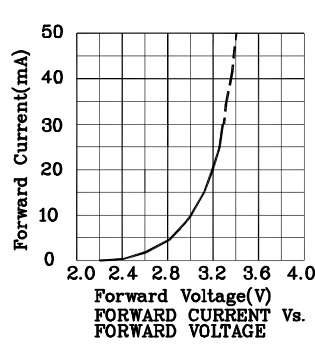
Absolute Maximum Ratings (TA=25°C)		M2DG (InGaN)	Unit
Reverse Voltage	VR	5	V
Forward Current	IF	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	iFS	100	mA
Power Dissipation	PD	120	mW
Operating Temperature	TA	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +85	

Operating Characteristics (TA=25°C)		M2DG (InGaN)	Unit
Forward Voltage (Typ.) (IF=20mA)	VF	3.2	V
Forward Voltage (Max.) (IF=20mA)	VF	4.0	V
Reverse Current (Max.) (VR=5V)	IR	10	uA
Wavelength of Peak Emission (Typ.) (IF=20mA)	$\lambda P$	520	nm
Wavelength of Dominant Emission (Typ.) (IF=20mA)	$\lambda D$	525	nm
Spectral Line Full Width At Half-Maximum (Typ.) (IF=20mA)	$\Delta\lambda$	35	nm
Capacitance (Typ.) (VF=0V, f=1MHz)	C	100	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=20mA) mcd		Viewing Angle 2 $\theta$ 1/2
				min.	typ.	
XZM2DG105W	Green	InGaN	Water Clear	1200	1590	125°

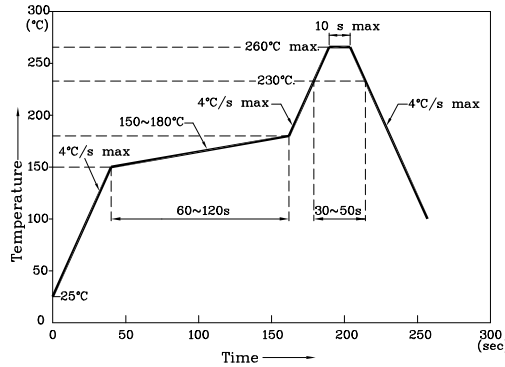


❖ M2DG



**Reflow soldering is recommended and the soldering profile is shown below.**  
**Other soldering methods are not recommended as they might cause damage to the product.**

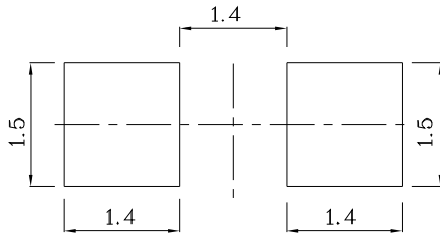
Reflow Soldering Profile For Lead-free SMT Process.



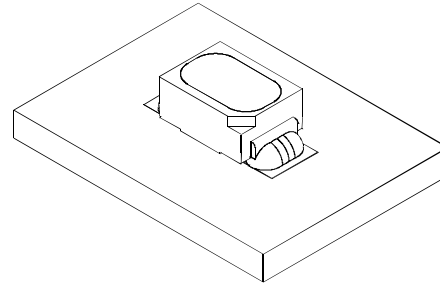
NOTES:

1. Maximum soldering temperature should not exceed 260°C.
2. Recommended reflow temperature: 145°C-260°C.
3. Do not put stress to the epoxy resin during high temperatures conditions.

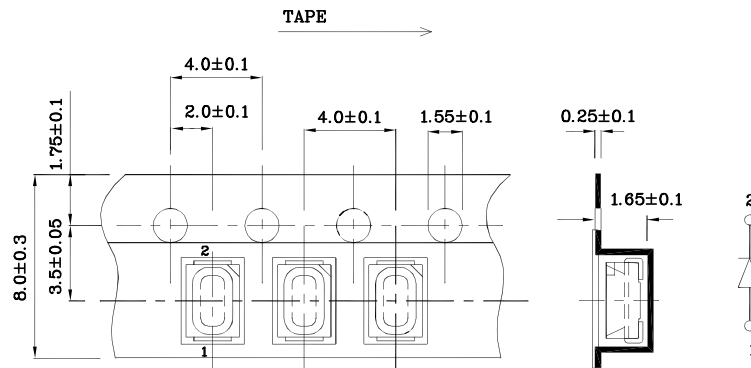
❖ **Recommended Soldering Pattern**  
 (Units : mm; Tolerance: ±0.1)



❖ **The device has a single mounting surface. The device must be mounted according to the specifications.**



❖ **Tape Specification (Units : mm)**



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

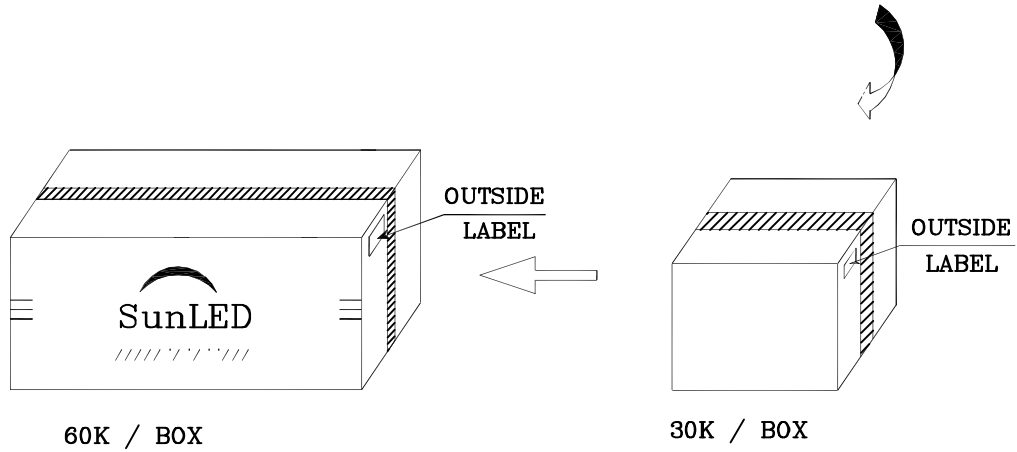
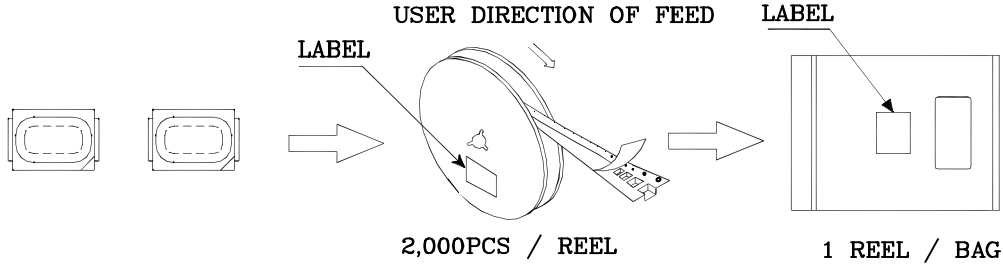

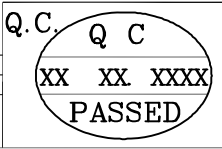
1. Wavelength: +/-1nm
2. Luminous intensity / luminous flux: +/-15%
3. Forward Voltage: +/-0.1V


Note: Accuracy may depend on the sorting parameters.



**PACKING & LABEL SPECIFICATIONS**

**XZM2DG105W**

P/NO : XZxxx105x	
QTY : 2,000 pcs	CODE: XXX
S/N : XX	
LOT NO :	
 XXXXXXXXXXXXXXXXXXXXXXXX	
RoHS Compliant	